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Diodes Incorporated DMG6602SVTQ-7

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Datasheet of DMG6602SVTQ-7 - MOSFET N/P-CH 30V TSOT26

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DMG6602SVTQ

#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
Q1	30V 60mΩ @ V <sub>GS</sub> = 10V		3.4A
Qi	300	100mΩ @ V <sub>GS</sub> = 4.5V	2.7A
Q2	-30V	95mΩ @ V <sub>GS</sub> = -10V	
QZ	-307	140mΩ @ V <sub>GS</sub> = -4.5V	-2.3A

# **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(on)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- **DC-DC Converters**
- **Power Management Functions**

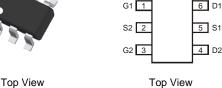
#### **Features and Benefits**

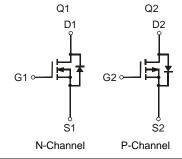
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **Mechanical Data**

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.013 grams (Approximate)







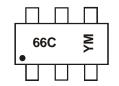
#### Ordering Information (Note 5)

Part Number	Case	Packaging
DMG6602SVTQ-7	TSOT26	3,000 / Tape & Reel
DMG6602SVTQ-13	TSOT26	10,000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**



66C = Product Type Marking Code YM = Date Code Marking Y = Year (ex: X = 2010)M = Month (ex: 9 = September)

Date Code Key

Year	2010	2011	2012	2013	201	4 20	15	2016	2017	2018	2019	2020
Code	X	Υ	Z	Α	В	(		D	Е	F	G	Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	2	4	-	6	7	0	٥		NI	ח

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DMG6602SVTQ

### Maximum Ratings - Q1 (@TA = +25°C unless otherwise specified.)

Characteristi	Symbol	Value	Unit		
Drain-Source Voltage			$V_{DSS}$	30	V
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Drain Current (Note 7) V <sub>GS</sub> = 10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	3.4 2.7	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = 4.5V	I <sub>D</sub>	2.7 2.2	А		
Maximum Continuous Body Diode Forward Current (	Is	1.5	Α		
Pulsed Drain Current (Note 5)	•		I <sub>DM</sub>	25	Α

## **Maximum Ratings – Q2** (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			$V_{DSS}$	-30	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 7) V <sub>GS</sub> = -10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	-2.8 -2.4	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = -4.5V	I <sub>D</sub>	-2.3 -2.1	А		
Maximum Continuous Body Diode Forward Current (	Is	-1.5	Α		
Pulsed Drain Current (Note 7)			ΙD	-20	Α

### **Thermal Characteristics**

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 6)	$T_A = +25$ °C	D	0.84	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	$P_{D}$	0.52	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Ъ	155	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	109		
Total Power Dissipation (Note 7)	$T_A = +25$ °C	В	1.27	W	
Total Power Dissipation (Note 7)	$T_A = +70^{\circ}C$	$P_{D}$	0.8	v v	
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Ъ	102	İ	
Thermal Resistance, Junction to Ambient (Note 1)	t<10s	$R_{\theta JA}$	71	°C/W	
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	34		
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

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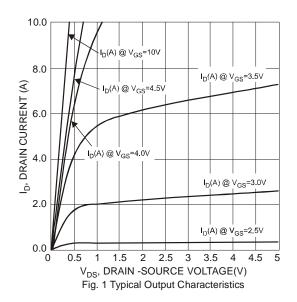
DMG6602SVTQ

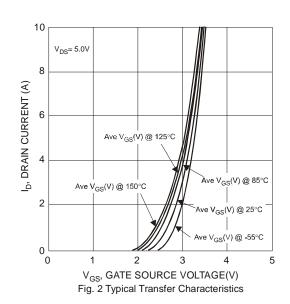
### Electrical Characteristics - Q1 NMOS (@ T<sub>A</sub> = +25°C unless otherwise stated.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-	-	1.0	μΑ	$V_{DS} = 24V$ , $V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	$V_{GS(th)}$	1.0	-	2.3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance			38	60	mΩ	$V_{GS} = 10V, I_D = 3.1A$
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	-	55	100	11122	$V_{GS} = 4.5V, I_D = 2A$
Forward Transfer Admittance	Y <sub>fs</sub>	-	4	-	S	$V_{DS} = 5V, I_{D} = 3.1A$
Diode Forward Voltage	V <sub>SD</sub>	-	0.8	1	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C <sub>iss</sub>	-	290	400		1514.14
Output Capacitance	Coss	-	40	80	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.2MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	-	40	80		1 = 1.21/11 12
Gate Resistance	Rg	-	1.4	-	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	-	4	6		$V_{DS} = 15V, V_{GS} = 4.5V, I_{D} = 3.1A$
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	-	9	13	nC	
Gate-Source Charge	Q <sub>gs</sub>	-	1.2	-	IIC	$V_{DS} = 15V, V_{GS} = 10V, I_{D} = 3A$
Gate-Drain Charge	Q <sub>gd</sub>	-	1.5	-		
Turn-On Delay Time	t <sub>D(on)</sub>	-	3	-		
Turn-On Rise Time	t <sub>r</sub>	-	5	-	no	$V_{GS} = 10V, V_{DS} = 15V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	-	13	-	ns	$R_G = 3\Omega$ , $R_L = 4.7\Omega$
Turn-Off Fall Time	t <sub>f</sub>	-	3	-		

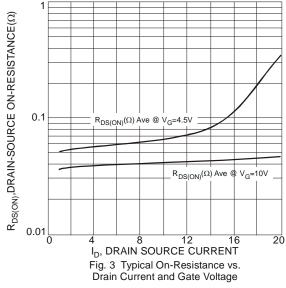
Notes: 8. Short duration pulse test used to minimize self-heating effect.

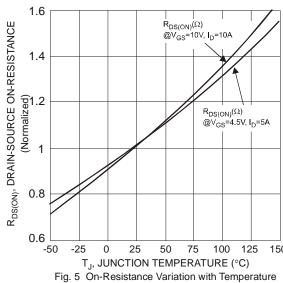
9. Guaranteed by design. Not subject to product testing.

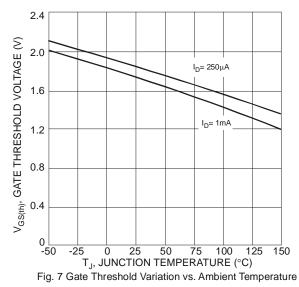


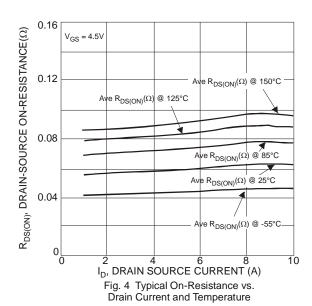


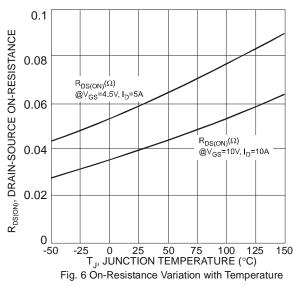
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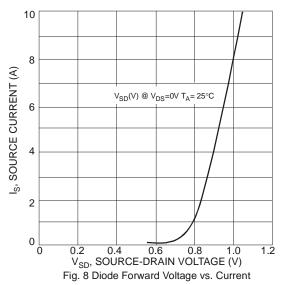




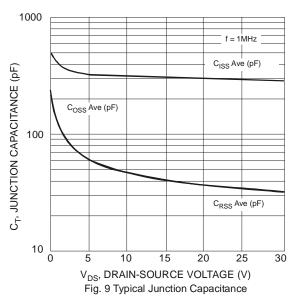


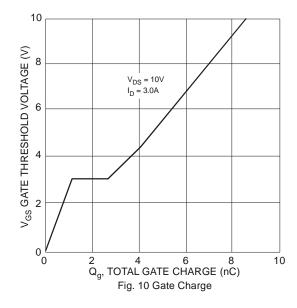


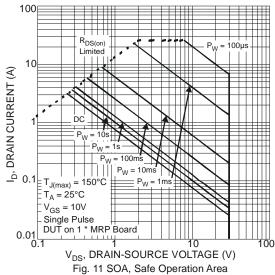












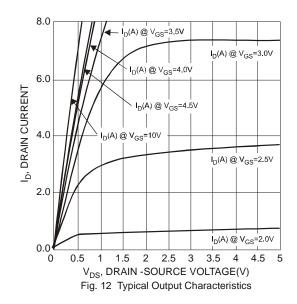


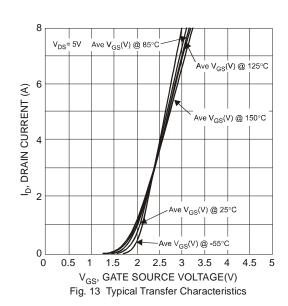
## Electrical Characteristics - Q2 PMOS (@ T<sub>A</sub> = +25°C unless otherwise stated.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	1 2					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	1	-	-1.0	μΑ	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	1	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1.0	-	-2.3	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
Static Drain-Source On-Resistance	Pno (01)	_	73	95	mΩ	$V_{GS} = -10V, I_D = -2.7A$
Static Diain-Source On-Resistance	R <sub>DS</sub> (ON)	_	99	140	11152	$V_{GS} = -4.5V, I_D = -2A$
Forward Transfer Admittance	Y <sub>fs</sub>	-	6	-	S	$V_{DS} = -5V$ , $I_{D} = -2.7A$
Diode Forward Voltage	$V_{SD}$	1	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C <sub>iss</sub>	•	350	420		15)(1)(-0)(
Output Capacitance	Coss	1	50	100	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.2MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	•	45	80		1 – 1.21/11 12
Gate Resistance	Rg	-	17.1	-	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	-	4	6		$V_{DS} = -15V$ , $V_{GS} = -4.5V$ , $I_{D} = -3A$
Total Gate Charge (V <sub>GS</sub> = -10V)	$Q_{g}$	1	7	9	nC	
Gate-Source Charge	$Q_gs$	•	0.9	-	IIC	$V_{DS} = -15V$ , $V_{GS} = -10V$ , $I_{D} = -3A$
Gate-Drain Charge	$Q_{gd}$	-	1.2	-		
Turn-On Delay Time	t <sub>D(on)</sub>	ı	4.8	-		
Turn-On Rise Time	t <sub>r</sub>	ı	7.3	-	ns	$V_{GS} = -10V, V_{DS} = -15V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	ı	20	-	115	$R_G = 6\Omega$ , $R_L = 15\Omega$
Turn-Off Fall Time	t <sub>f</sub>	ı	13	-		

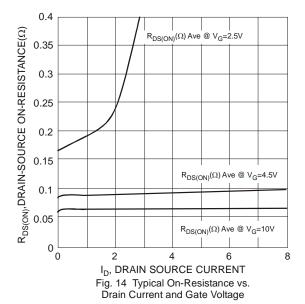
Notes:

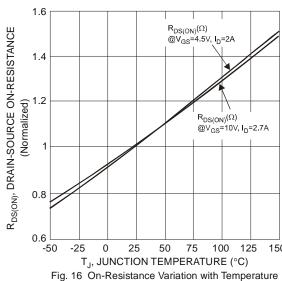
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

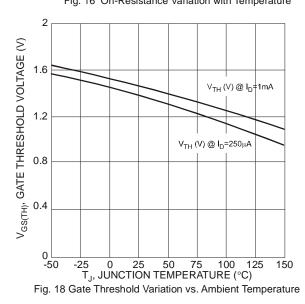












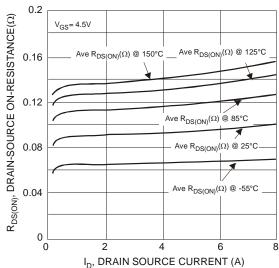


Fig. 15 Typical On-Resistance vs. Drain Current and Temperature

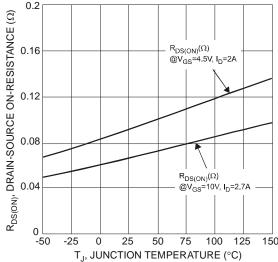


Fig. 17 On-Resistance Variation with Temperature

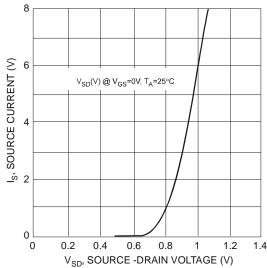
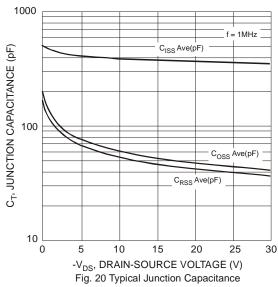
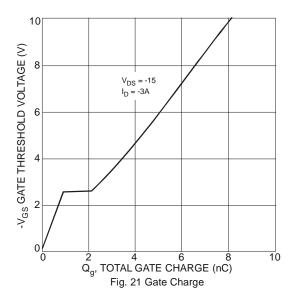
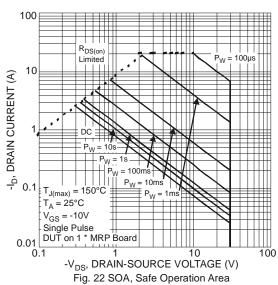


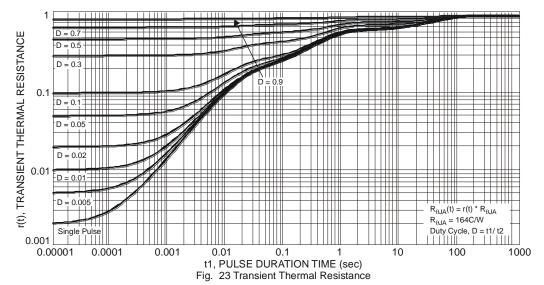
Fig. 19 Diode Forward Voltage vs. Current











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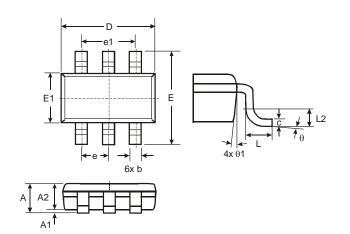
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DMG6602SVTQ

## **Package Outline Dimensions**

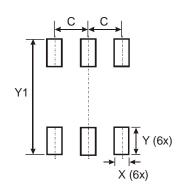
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



TSOT26							
Dim	Min	Max	Тур				
Α	_	1.00	_				
A1	0.01	0.10	_				
A2	0.84	0.90	_				
D	_	_	2.90				
Е	_	_	2.80				
E1	_	_	1.60				
b	0.30	0.45	_				
С	0.12	0.20	_				
е	_	_	0.95				
e1	_	_	1.90				
١	0.30	0.50					
L2	_	_	0.25				
θ	0°	8°	4°				
θ1	4°	12°	_				
All D	imensi	ons in	mm				

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Υ	1.000
Y1	3.199



Datasheet of DMG6602SVTQ-7 - MOSFET N/P-CH 30V TSOT26

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DMG6602SVTQ

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  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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